

BYS459-1500, BYS459F-1500 BYS459B-1500

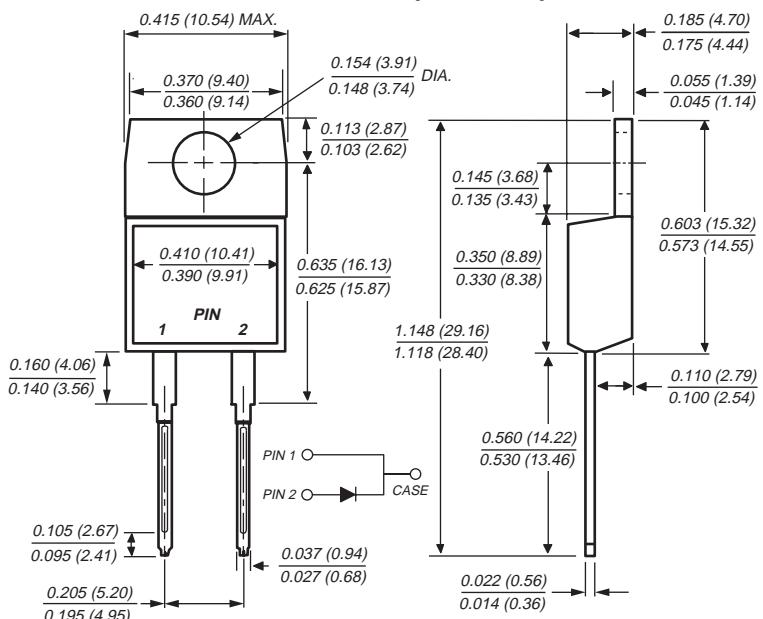
High Voltage Damper Diodes

Reverse Voltage 1500V

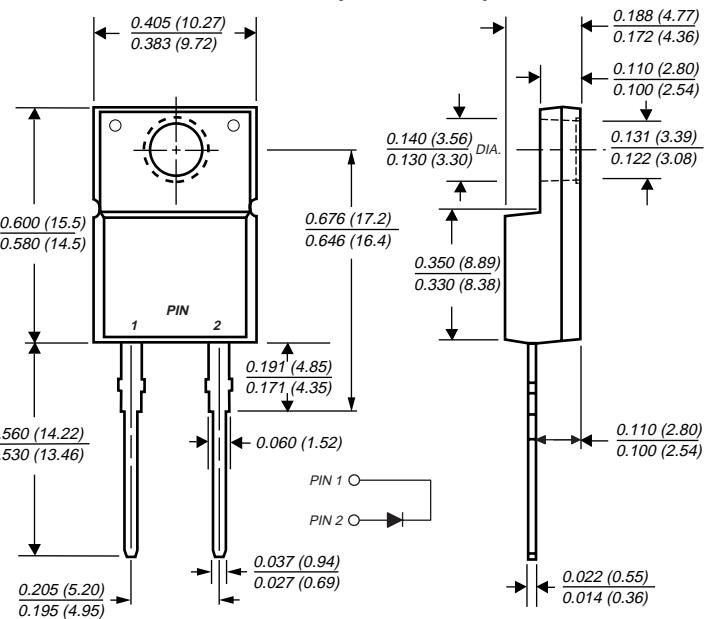
Forward Current 6.5A

Reverse Recovery Time 350ns

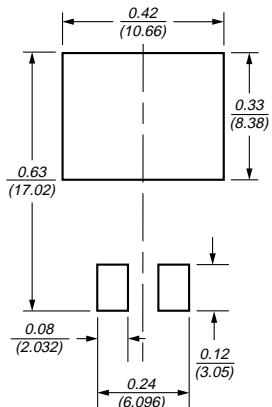
TO-220AC (BYS459)



ITO-220AC (BYS459F)



Mounting Pad Layout TO-263AB



Dimensions in inches and (millimeters)

Mechanical Data

Case: JEDEC TO-220AC, ITO-220AC & TO-263AB molded plastic body

Terminals: Plated leads, solderable per MIL-STD-750, Method 2026

Polarity: As marked

Mounting Position: Any

Mounting Torque: 10 in-lbs maximum

Weight: 0.08 ounce, 2.24 grams

Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Ideally suited CRT horizontal deflection
- Fast reverse recovery time
- Fast forward recovery time
- High temperature soldering in accordance with CECC 802 / Reflow guaranteed
- Glass passivated chip junction

6/20/01

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Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	1500	V
Maximum working reverse voltage	V _{RWM}	1300	V
Maximum DC blocking voltage	V _{DC}	1500	V
Maximum average forward rectified current	I _{F(AV)}	6.5	A
Peak working forward current at $f = 48\text{kHz}$	I _{F(Peak)}	12	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) at $T_J = 150^\circ\text{C}$	I _{FSM}	130	A
Operating junction and storage temperature range	T _J , T _{TSG}	-55 to +150	°C
RMS Isolation voltage (BYS459F types only) from terminals to heatsink with $t = 1.0$ second, $\text{RH} \leq 30\%$	V _{ISOL}	4500 ⁽¹⁾ 3500 ⁽²⁾ 1500 ⁽³⁾	V

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum instantaneous forward voltage ⁽⁴⁾ $I_F = 6.5\text{A}, T_J = 25^\circ\text{C}$ $I_F = 6.5\text{A}, T_J = 125^\circ\text{C}$	V _F	1.3 1.2	V
Maximum DC reverse current at V _{RWM} $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	I _R	250 1.0	μA mA
Maximum reverse recovery time at $I_F = 1.0\text{A}, dI/dt = 50\text{A}/\mu\text{s}, V_R = 30\text{V}$	t _{rr}	350	ns
Maximum reverse recovery charge at $I_F = 2.0\text{A}, -dI/dt = 20\text{A}/\mu\text{s}$	Q _{rr}	3.0	μC
Maximum forward recovery time $I_F = 6.5\text{A}, dI/dt = 52\text{A}/\mu\text{s}$	t _{frr}	250	ns
Peak forward recovery overshoot voltage $I_F = 6.5\text{A}, dI/dt = 52\text{A}/\mu\text{s}$	V _{FPP}	20	V

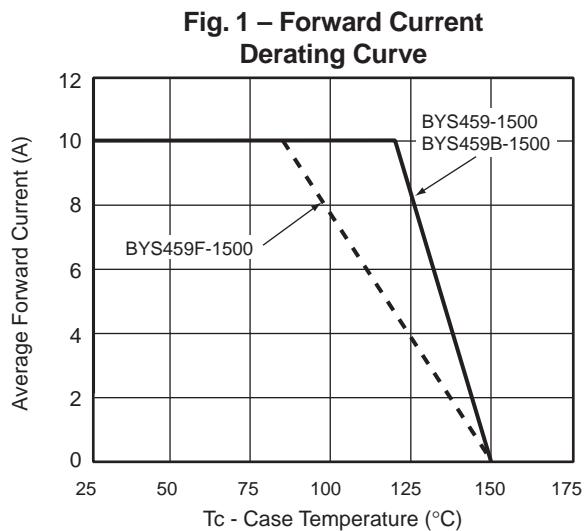
Thermal Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	BYS459	BYS459F	BYS459B	Unit
Typical thermal resistance from junction to ambient	R _{θJA}	60	55	60	°C/W

Notes:

- (1) Clip mounting (on case), where lead does not overlap heatsink with 0.110" offset
- (2) Clip mounting (on case), where leads do overlap heatsink
- (3) Screw mounting with 4-40 screw, where washer diameter is ≤ 4.9 mm (0.19")
- (4) Pulse test: 300μs pulse width, 1% duty cycle

**Ratings and
Characteristic Curves** ($T_A = 25^\circ\text{C}$ unless otherwise noted)



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